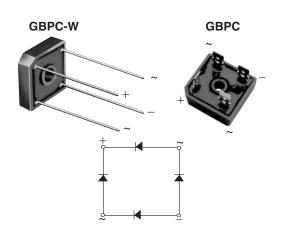


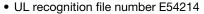
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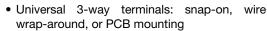
Glass Passivated Single-Phase Bridge Rectifier



PRIMARY CHARACTERISTICS								
I _{F(AV)}	12 A, 15 A, 25 A, 35 A							
V _{RRM}	50 V to 1000 V							
I _{FSM}	200 A, 300 A, 300 A, 400 A							
I _R	5 μΑ							
V _F	1.1 V							
T _J max.	150 °C							

FEATURES







• Typical I_R less than 0.3 μA

High surge current capability

· Low thermal resistance

Solder dip 260 °C, 40 s

 Compliant to RoHS Directive 2002/95/EC accordance to WEEE 2002/96/EC

TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for power supply, home appliances, office equipment, industrial automation applications.

MECHANICAL DATA

Case: GBPC. GBPC-W

Epoxy meets UL 94 V-0 flammability rating

Terminals: Nickel plated on faston lugs or silver plated on wire leads, solderable per J-STD-002 and JESD22-B102. E4 suffix for consumer grade. Suffix letter "W" added to

indicate wire leads (e.g. GBPC12005W).

Polarity: As marked, positive lead by belevled corner

Mounting Torque: 20 inches-lbs. max.

PARAMETER		SYMBOL			GBPC	C12, 15, 2	25, 35			UNIT
			005	01	02	04	06	08	10	
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V	
Maximum RMS voltage		V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage		V_{DC}	50	100	200	400	600	800	1000	V
	GBPC12	I _{F (AV)}				12				
Maximum average forward rectified output current (Fig. 1)	GBPC15		15							
	GBPC25		25							A
	GBPC35				35					
	GBPC12		200							
Peak forward surge current single	GBPC15		300							
sine-wave superimposed on rated load	GBPC25	I _{FSM}	300							Α
	GBPC35		400							1
	GBPC12		160							
Rating (non-repetitive, for t greater than 1 ms and less than 8.3 ms) for fusing	GBPC15	l ² t	375							- A ² s
	GBPC25	1-1	375							
	GBPC35		660							
RMS isolation voltage from case to leads	V _{ISO}	2500							٧	
Operating junction storage temperature ra	T _J , T _{STG}	- 55 to + 150							°C	

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GBPC12, GBPC15, GBPC25, GBPC35

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)											
PARAMETER		TEST CONDITIONS	SYMBOL	GBPC12, 15, 25, 35							UNIT
				005	01	02	04	06	08	10	UNIT
	GBPC12	I _F = 6.0 A									
Maximum instantaneous forward drop per diode	GBPC15	I _F = 7.5 A	V _F	1.1							V
	GBPC25	I _F = 12.5 A									V
	GBPC35	I _F = 17.5 A									
Maximum reverse DC current at rated DC blocking voltage per diode		T _A = 25 °C		5.0 500							
		T _A = 125 °C	- I _R								μΑ
Typical junction capacitanc	e per diode	4 V, 1 MHz	CJ	C _J 300				300			pF

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)										
PARAMETER		SYMBOL	GBPC12, 15, 25, 35							
			005	01	02	04	06	80	10	UNIT
Typical thormal registance	GBPC12 to GBPC25	R _{θJC} ⁽¹⁾	1.9						°C/W	
Typical thermal resistance	GBPC35	L _θ JC (.)	1.4							C/W

Notes

⁽²⁾ Bolt down on heatsink with silicone thermal compound between bridge and mounting surface for maximum heat transfer with #10 screw

ORDERING INFORMATION (Example)										
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE						
GBPC1206-E4/51	15.79	51	100	Paper box						
GBPC1506-E4/51	15.79	51	100	Paper box						
GBPC2506-E4/51	15.79	51	100	Paper box						
GBPC3506-E4/51	15.79	51	100	Paper box						
GBPC1206W-E4/51	13.8	51	100	Paper box						
GBPC1506W-E4/51	13.8	51	100	Paper box						
GBPC2506W-E4/51	13.8	51	100	Paper box						
GBPC3506W-E4/51	13.8	51	100	Paper box						

⁽¹⁾ With heatsink

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RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

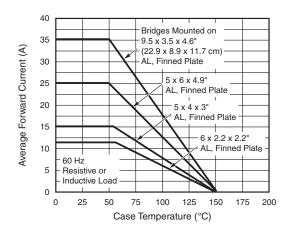


Fig. 1 - Maximum Output Rectified Current

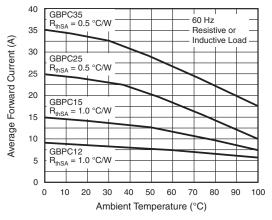


Fig. 2 - Maximum Output Rectified Current

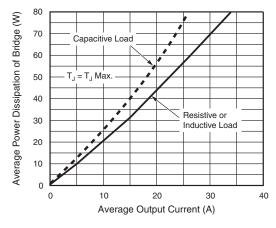


Fig. 3 - Maximum Power Dissipation

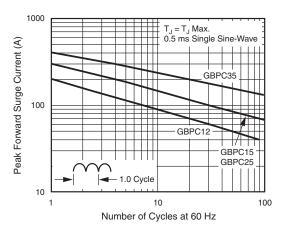


Fig. 4 - Maximum Non-Repetitive Peak Forward Surge Current Per Diode

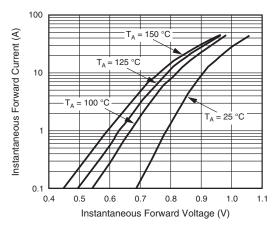


Fig. 5 - Typical Instantaneous Forward Characteristics Per Diode

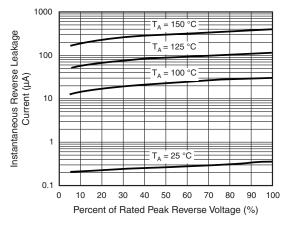
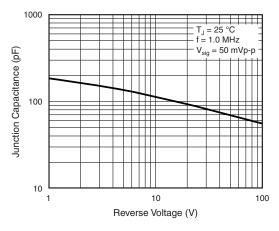


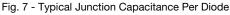
Fig. 6 - Typical Reverse Leakage Characteristics Per Diode

GBPC12, GBPC15, GBPC25, GBPC35

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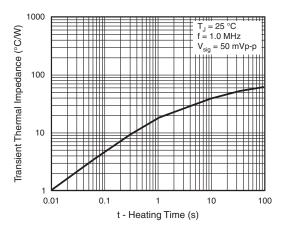
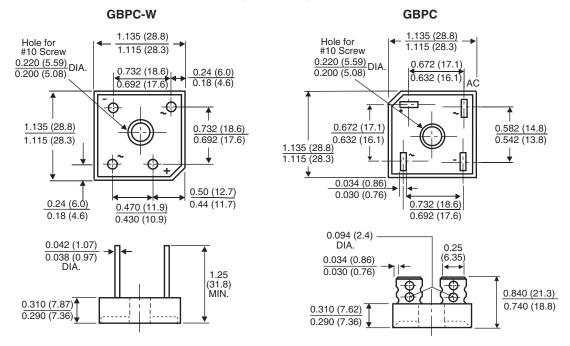


Fig. 8 - Typical Transient Thermal Impedance Per Diode

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

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